



Material Content Data Sheet



Sales Product Name		SPA03N60C3		Issued		26. September 2017			
MA#		MA001579036							
Package		PG-TO220-3-317		Weight*		2113.68 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	2.326	0.11	0.11	1100	1100	
leadframe	non noble metal	iron	7439-89-6	1.202	0.06		569		
	inorganic material	phosphorus	7723-14-0	0.361	0.02		171		
	non noble metal	copper	7440-50-8	1200.685	56.80	56.88	568054	568794	
wire	non noble metal	aluminium	7429-90-5	7.940	0.38	0.38	3756	3756	
encapsulation	organic material	carbon black	1333-86-4	8.900	0.42		4211		
	plastics	epoxy resin	-	142.854	6.76		67585		
	inorganic material	silicondioxide	60676-86-0	739.855	35.00	42.18	350031	421827	
leadfinish	non noble metal	tin	7440-31-5	7.889	0.37	0.37	3732	3732	
solder	non noble metal	antimony	7440-36-0	0.167	0.01		79		
	noble metal	silver	7440-22-4	0.418	0.02		198		
	non noble metal	tin	7440-31-5	1.086	0.05	0.08	514	791	
*deviation	< 10%					Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com